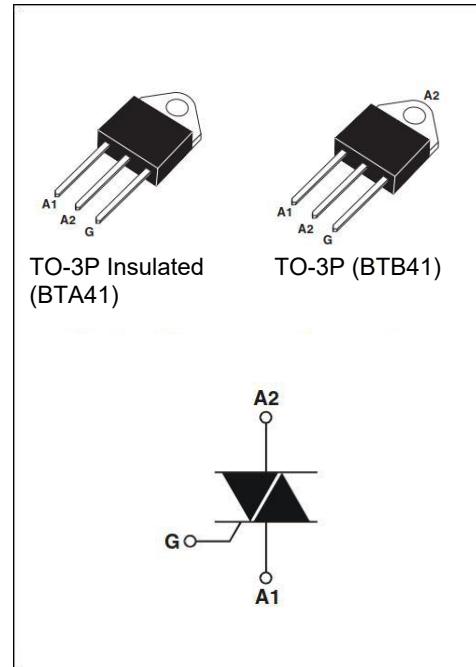


DESCRIPTION:

BTA41 BTB41 series triacs, with high ability to withstand the shock loading of large current, provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended for use on inductive load.

MAIN FEATURES

Symbol	Value	Unit
$I_{T(RMS)}$	40	A
V_{DRM}/V_{RRM}	600/800/1200/1600	V
V_{TM}	1.55	V



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	T_{stg}	-40-150	°C
Operating junction temperature range	T_j	-40-125	°C
Repetitive peak off-state voltage ($T_j=25^\circ C$)	V_{DRM}	600/800/1200/1600	V
Repetitive peak reverse voltage ($T_j=25^\circ C$)	V_{RRM}	600/800/1200/1600	V
Non repetitive surge peak Off-state voltage	V_{DSM}	$V_{DRM} + 100$	V
Non repetitive peak reverse voltage	V_{RSM}	$V_{RRM} + 100$	V
RMS on-state current	$I_{T(RMS)}$	40	A
TO-3P _{Ins} ($T_C=80^\circ C$)			
TO-3P ($T_C=90^\circ C$)			
Non repetitive surge peak on-state current (full cycle, $F=50Hz$)	I_{TSM}	400	A
I^2t value for fusing ($t_p=10ms$)	I^2t	880	A ² s
Critical rate of rise of on-state current ($I_G = 2 \times I_{GT}$)	dI/dt	50	A/μs
Peak gate current	I_{GM}	4	A
Average gate power dissipation	$P_{G(AV)}$	1	W
Peak gate power	P_{GM}	10	W

ELECTRICAL CHARACTERISTICS (T_j=25°C unless otherwise specified)
3 Quadrants

Symbol	Test Condition	Quadrant		Value	Unit
I _{GT}	V _D =12V R _L =33Ω	I - II - III	MAX	50	mA
V _{GT}		I - II - III	MAX	1.3	V
V _{GD}	V _D =V _{DRM} T _j =125°C R _L =3.3KΩ	I - II - III	MIN	0.2	V
I _L	I _G =1.2I _{GT}	I - III	MAX	80	mA
		II		100	
I _H	I _T =100mA		MAX	60	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T _j =125°C		MIN	1000	V/μs
(dV/dt)c	Without snubber T _j =125°C		MIN	20	V/μs

4 Quadrants

Symbol	Test Condition	Quadrant		Value	Unit
I _{GT}	V _D =12V R _L =33Ω	I - II - III	MAX	50	mA
		IV		70	
V _{GT}		ALL	MAX	1.5	V
V _{GD}	V _D =V _{DRM} T _j =125°C R _L =3.3KΩ	ALL	MIN	0.2	V
I _L	I _G =1.2I _{GT}	I - III - IV	MAX	90	mA
		II		100	
I _H	I _T =100mA		MAX	80	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T=125°C		MIN	500	V/μs
(dV/dt)c	Without snubber T _j =125°C		MIN	30	V/μs

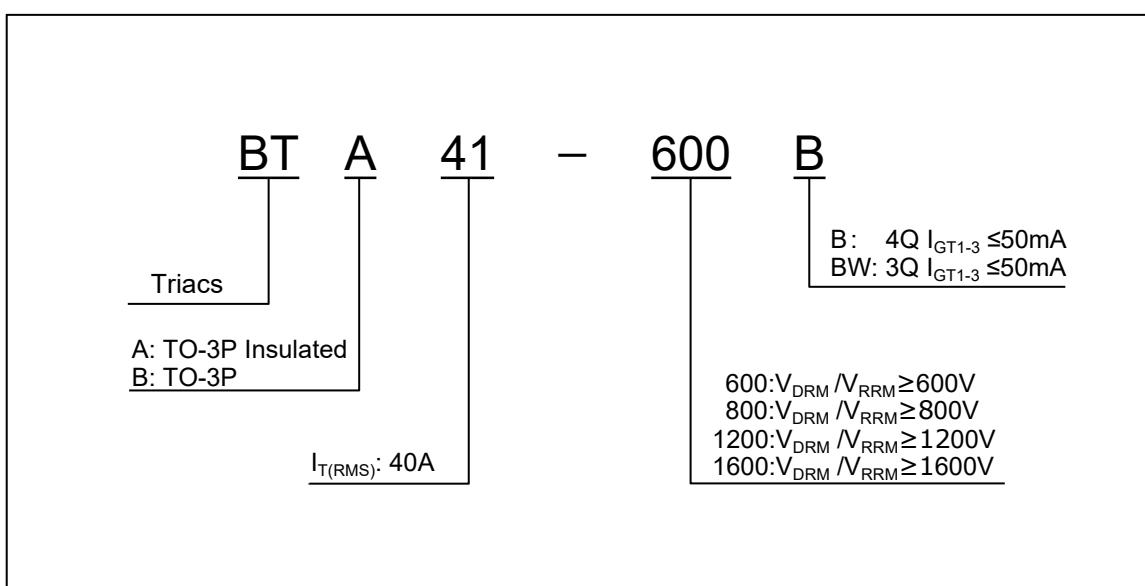
STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	$I_{TM} = 60A$ $t_p = 380\mu s$	$T_j = 25^\circ C$	1.55	V
I_{DRM}	$V_D = V_{DRM}$ $V_R = V_{RRM}$	$T_j = 25^\circ C$	10	μA
I_{RRM}		$T_j = 125^\circ C$	5	mA

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	junction to case(AC)	0.9	$^\circ C/W$
		0.8	

ORDERING INFORMATION



CHARACTERISTICS CURVES

FIG.1 Maximum power dissipation versus RMS on-state current

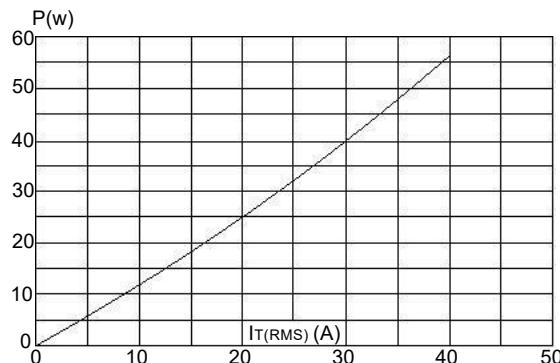


FIG.3: Surge peak on-state current versus number of cycles

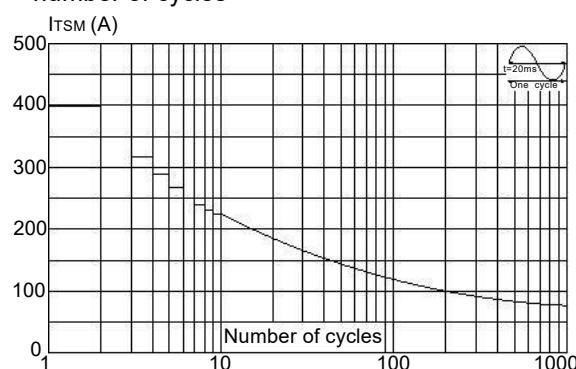


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 20\text{ms}$, and corresponding value of I^2t ($\text{d}I/\text{d}t < 50\text{A}/\mu\text{s}$)

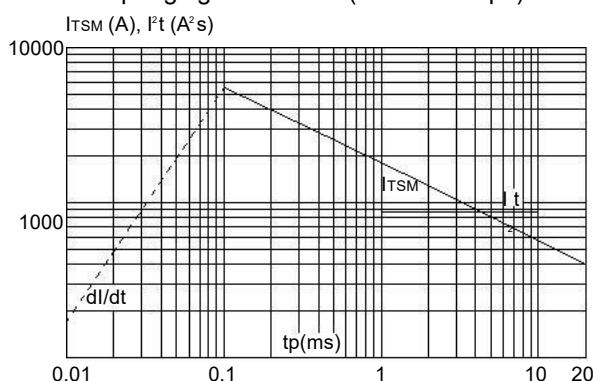


FIG.2: RMS on-state current versus case temperature

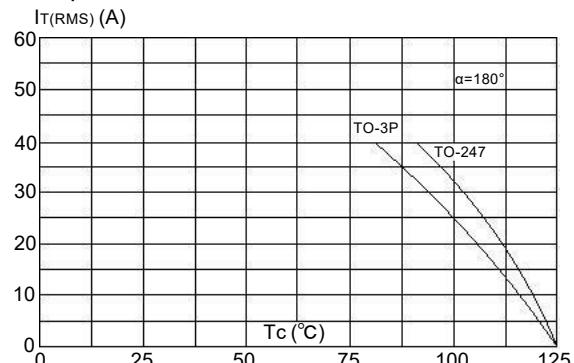


FIG.4: On-state characteristics (maximum values)

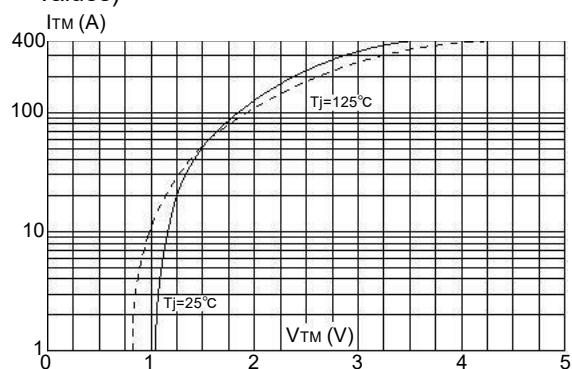
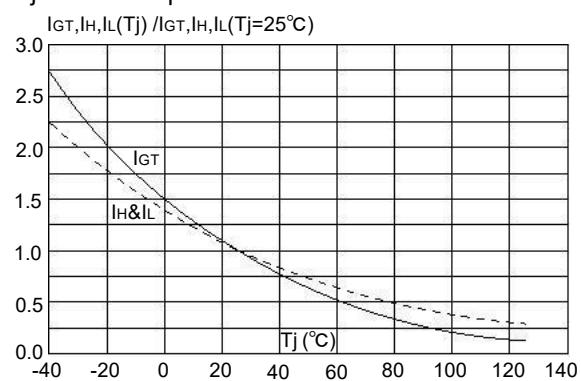
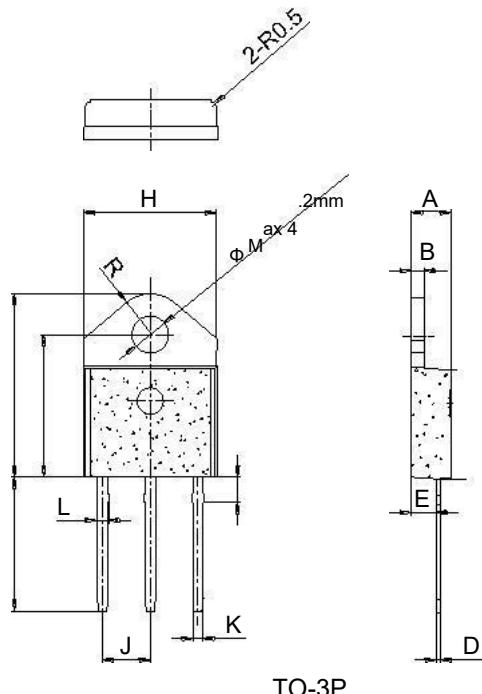


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



PACKAGE MECHANICAL DATA


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	1.45		1.55	0.057		0.061
C	14.35		15.60	0.565		0.614
D	0.50		0.70	0.020		0.028
E	2.70		2.90	0.106		0.114
F	15.80		16.50	0.622		0.650
G	20.40		21.10	0.803		0.831
H	15.10		15.50	0.594		0.610
J	5.40		5.65	0.213		0.222
K	1.10		1.40	0.043		0.055
L	1.35		1.50	0.053		0.059
P	2.80		3.00	0.110		0.118
R		4.35			0.171	